

Weidmüller Interface GmbH & Co. KG

Klingenbergstraße 26 D-32758 Detmold Germany

www.weidmueller.com

Product image





OMNIMATE[®] 4.0 - the next evolution step

OMNIMATE[®] 4.0 follows the trend of One Cable Technology (OCT). The modular concept enables the fast configuration of hybrid interfaces, which transmit data, signals and energy in a single connector. As a result, you can reduce the cabling effort in a wide variety of applications, simplify maintenance and accelerate automation processes. The unique SNAP IN connection is the backbone and speeds up the wiring process.

The fastest connection yet

- Fast, safe, and tool-free wiring due to unique SNAP IN connection
- Ready for Robot through "wire ready" delivery with open clamping point
- Optical and acoustic feedback indicates proper wiring
- **Create your own configuration**
- Flexible configuration and ordering via the Weidmüller Configurator (WMC)
- Dispatch within three days even for individually configured products
- Automatic offer preparation for the configurated product

Simply configuration of modular hybrid connectors

- Flexible combination options for power, signal and data transmission
- Future-proof Single-Pair Ethernet technology

General ordering data

| Version | PCB plug-in connector, male header, THT/THR | |
|--------------|--|--|
| | solder connection, Pitch in mm (P): 5.00 mm, | |
| | Number of poles: 4, 180°, Tube | |
| Order No. | <u>8000072431</u> | |
| Туре | MHS 5/04 V T3 B T | |
| GTIN (EAN) | 4064675423225 | |
| Qty. | 25 pc(s). | |
| Product data | IEC: 400 V / 25.3 A | |
| | UL: 300 V / 18.5 A | |
| Packaging | Tube | |

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Technical data



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| Depth | 11.9 mm | Depth (inches) | 0.469 inch |
|---|--|--|-----------------------|
| Height | 17.2 mm | Height (inches) | 0.677 inch |
| Height of lowest version | 14 mm | Width | 21.38 mm |
| Width (inches) | 0.842 inch | Net weight | 1.746 g |
| Temperatures | | | |
| Operating temperature, min. | -50 °C | Operating temperature, max. | 100 °C |
| System specifications | | | |
| Due du sé fansilu | | Time of compaction | De and a sur a stir a |
| Product family | OMNIMATE 4.0 | Type of connection | Board connection |
| Mounting onto the PCB | THT/THR solder connection | Pitch in mm (P) | 5 mm |
| Pitch in inches (P) | 0.197 inch | Outgoing elbow | 180° |
| Number of poles | 4 | Number of solder pins per pole | 1 |
| Solder pin length (I) | 3.2 mm | Solder pin dimensions | 1.0 x 1.0 mm |
| Solder eyelet hole diameter (D) | 1.4 mm | Solder eyelet hole diameter tolerance (E | |
| Outside diameter of solder pad | 2.3 mm | Template aperture diameter | 2.1 mm |
| L1 in mm | 15 mm | L1 in inches | 0.591 inch |
| Number of rows | 1 | Pin series quantity | 1 |
| Touch-safe protection acc. to DIN VDE 57 106 | Touch-safe above the printed circuit board | Touch-safe protection acc. to DIN VDE 0470 | IP 20 |
| Protection degree | IP20 | Volume resistance | ≤5 mΩ |
| Plugging cycles | ≥25 | Plugging force/pole, max. | 8.5 N |
| Pulling force/pole, max. | 8.5 N | | |
| Material data | | | |
| | DA OT | Calaura | bla ala |
| Insulating material | PA 9T | Colour | black I |
| Colour chart (similar) | RAL 9011 | Insulating material group | 1 |
| Comparative Tracking Index (CTI) | ≥ 600 V-0 | Moisture Level (MSL) | • |
| UL 94 flammability rating Contact material | CuMg | Contact base material Contact surface | CuMg tinned |
| Tinning type | matt | Storage temperature, min. | -25 °C |
| Storage temperature, max. | 55 °C | Operating temperature, min. | -50 °C |
| Operating temperature, max. | 100 °C | | -50 C |
| Rated data acc. to IEC | | | |
| | | | |
| tested acc. to standard | IEC 60664-1, IEC 61984 | Rated current, min. number of poles (Tu=20°C) | 25.3 A |
| Rated current, max. number of poles (Tu=20°C) | 20.8 A | Rated current, min. number of poles (Tu=40°C) | 21.8 A |
| Rated current, max. number of poles (Tu=40°C) | 18 A | Rated voltage for surge voltage class / pollution degree II/2 | 400 V |
| Rated voltage for surge voltage class / pollution degree III/2 | 320 V | Rated voltage for surge voltage class / pollution degree III/3 | 250 V |
| Rated impulse voltage for surge voltage class/ pollution degree II/2 | 4 kV | Rated impulse voltage for surge voltage class/ pollution degree III/2 | 4 kV |
| Rated impulse voltage for surge voltage class/ contamination degree III/3 Creepage distance, min. | 4 kV | Clearance, min. | 4 mm |
| | 5.4 mm | | |

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| Institute (cURus) | c R us | Certificate No. (cURus) | E60693 |
|--|--|---|---|
| Rated voltage (Use group B / UL 1059 |) 300 V | Rated voltage (Use group D / UL 1059) | |
| Rated voltage (Use group F / UL 1059 | | Rated current (Use group B / UL 1059) | |
| Rated current (Use group D / UL 1059 | | Clearance distance, min. | 4 mm |
| Creepage distance, min. | 5 0 mm | Reference to approval values | Specifications are maximum values, details |
| ol 'r' /' | 5.6 mm | | see approval certificate. |
| Classifications | | | |
| ETIM 6.0 | EC002637 | ETIM 7.0 | EC002637 |
| ETIM 8.0 | EC002637 | ECLASS 9.0 | 27-44-04-02 |
| ECLASS 9.1 | 27-44-04-02 | ECLASS 10.0 | 27-44-04-02 |
| ECLASS 11.0 | 27-46-02-01 | ECLASS 12.0 | 27-46-02-01 |
| Important note | | | |
| | | ly with the assured properties in the data sheet | |
| Votes | in accordance with IPC-A-610¹⁰C Rated current related to rated P on drawing = pitch Rated data refer only to the cobe designed in accordance w Diameter of solder eyelet D = | by with the assured properties in the data sheet Class 2". Further claims on the products can be cross-section & min. No. of poles. The properties of the product of the pr | resp. fulfill decorative propertievaluated on request. |
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| Approvals Approvals UL File Number Search Certificate No. (cURus) | in accordance with IPC-A-610¹⁰C Rated current related to rated P on drawing = pitch Rated data refer only to the cobe designed in accordance w Diameter of solder eyelet D = Long term storage of the procession | ly with the assured properties in the data sheet Class 2". Further claims on the products can be cross-section & min. No. of poles. omponent itself. Clearance and creepage distan- ith the relevant application standards. 1.4+0.1mm fuct with average temperature of 50 °C and ave | resp. fulfill decorative propertievaluated on request. |
| Approvals Approvals JL File Number Search Certificate No. (cURus) Downloads Approval/Certificate/Document of | in accordance with IPC-A-610 ^T C Rated current related to rated P on drawing = pitch Rated data refer only to the co be designed in accordance w Diameter of solder eyelet D = Long term storage of the proc UL Website E60693 | ly with the assured properties in the data sheet Class 2". Further claims on the products can be of cross-section & min. No. of poles. Imponent itself. Clearance and creepage distan- ith the relevant application standards. 1.4+0.1mm duct with average temperature of 50 °C and aver | resp. fulfill decorative properti evaluated on request. ces to other components are t |
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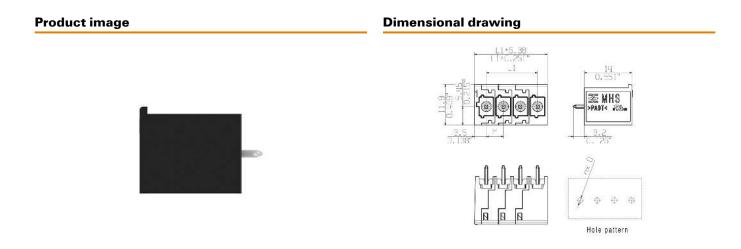
Drawings



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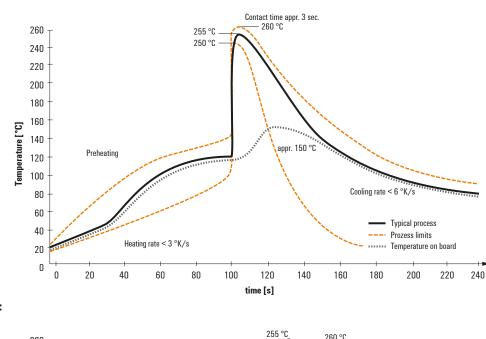
Wave Solder Profile

Recommended wave solderding profiles

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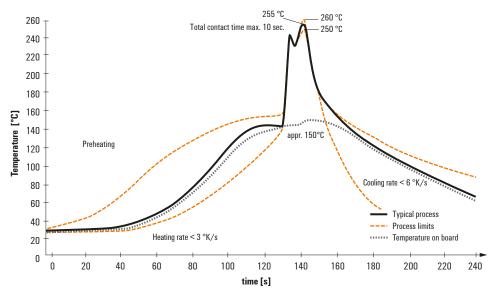
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Double Wave:

Single Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

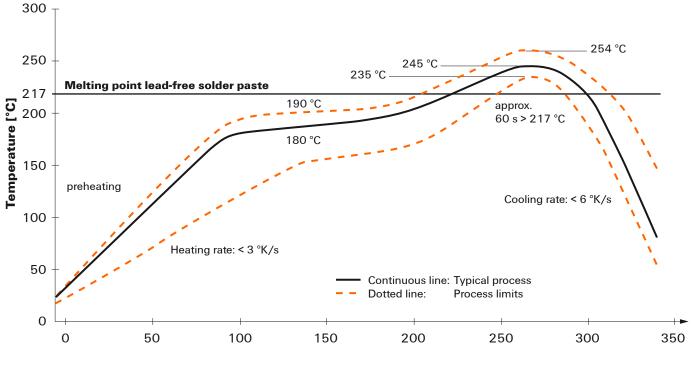
Reflow Solder Profile

Recommended reflow soldering profile



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Time [sec]

Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3$ K/s. In parallel the solder paste is ,activated'. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at \geq -6K/s solder is cured. Board and components cool down while avoiding cold cracks.